

6A, 650V N-CHANNEL POWER MOSFET

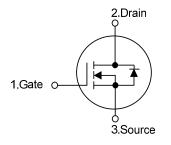
DESCRIPTION

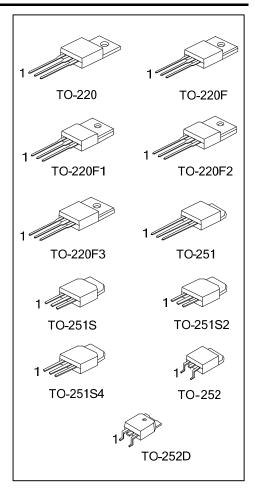
The UTC **6N65K-MT** is a high voltage power MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

FEATURES

- * $R_{DS(ON)}$ < 1.5 Ω @V_{GS} = 10V, I_D = 3A
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

SYMBOL

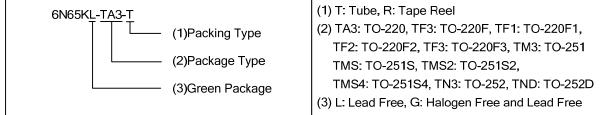




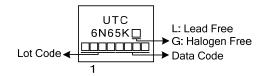
Power MOSFET

ORDERING INFORMATION

Ordering Number		Dookago	Pin Assignment			Decking
Lead Free	Halogen Free	Package	1	2	3	Packing
6N65KL-TA3-T	6N65KG-TA3-T	TO-220	G	D	S	Tube
6N65KL-TF3-T	6N65KG-TF3-T	TO-220F	G	D	S	Tube
6N65KL-TF1-T	6N65KG-TF1-T	TO-220F1	G	D	S	Tube
6N65KL-TF2-T	6N65KG-TF2-T	TO-220F2	G	D	S	Tube
6N65KL-TF3-T	6N65KG-TF3-T	TO-220F3	G	D	S	Tube
6N65KL-TM3-T	6N65KG-TM3-T	TO-251	G	D	S	Tube
6N65KL-TMS-T	6N65KG-TMS-T	TO-251S	G	D	S	Tube
6N65KL-TMS2-T	6N65KG-TMS2-T	TO-251S2	G	D	S	Tube
6N65KL-TMS4-T	6N65KL-TMS4-T 6N65KG-TMS4-T		G	D	S	Tube
6N65KL-TN3-R	6N65KL-TN3-R 6N65KG-TN3-R		G	D	S	Tape Reel
6N65KL-TND-R 6N65KG-TND-R		TO-252D	G	D	S	Tape Reel
Note: Pin Assignment: G: Gate D: Drain S: Source						



MARKING





PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	650	V
Gate-Source Voltage		V _{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	6	А
Continuous Drain Current		I _D	6	А
Pulsed Drain Current (Note 2)		I _{DM}	24	А
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	300	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	ns
	TO-220	PD	125	W
Power Dissipation	TO-220F/TO-220F1 TO-220F3		40	W
	TO-220F2		42	W
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		55	W
Junction Temperature		TJ	+150	°C
Operating Temperature		T _{OPR}	-55 ~ +150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

■ ABSOLUTE MAXIMUM RATINGS (T_c = 25°C, unless otherwise specified)

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by $T_{\rm J}$
- 3. L = 16.6mH, I_{AS} = 6A, V_{DD} = 90V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 6A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3	0	62.5	°044	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D	θ _{JA}	110	°C/W	
Junction to Case	TO-220	θις	1.0		
	TO-220F/TO-220F1 TO-220F3		3.2		
	TO-220F2		2.97	°C/W	
	TO-251/TO-251S TO-251S2/TO-251S4 TO-252/TO-252D		2.27		



PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250µA	650			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V			10	μA
Gate- Source Leakage Current		$V_{GS} = 30V, V_{DS} = 0V$			100	nA
Reverse	- I _{GSS}	$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
Breakdown Voltage Temperature Coefficient	: ∆BV _{DSS} /∆T _J	I _D =250µA, Referenced to 25°C		0.53		V/°C
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0		4.0	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 3A			1.5	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}			875	1000	pF
Output Capacitance	C _{OSS}	-V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		88	120	рF
Reverse Transfer Capacitance	C _{RSS}			8	25	рF
SWITCHING CHARACTERISTICS				-		
Turn-On Delay Time	t _{D(ON)}			50	60	ns
Turn-On Rise Time	t _R	V _{DD} =30V, I _D =0.5A,		65	80	ns
Turn-Off Delay Time	t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		110	130	ns
Turn-Off Fall Time	t _F			55	70	ns
Total Gate Charge	Q_{G}	V _{DS} =50V, I _D =1.3A,		22.5	40	nC
Gate-Source Charge	Q _{GS}	$V_{GS}=30V$, $I_D=1.3A$, $V_{GS}=10V$ (Note 1, 2)		7.5		nC
Gate-Drain Charge	Q _{GD}			5		nC
DRAIN-SOURCE DIODE CHARACTERIST	CS AND MAXI	MUM RATINGS				_
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} = 0 V, I _S = 6 A			1.4	V
Maximum Continuous Drain-Source Diode	ls				6	А
Forward Current					U	A
Maximum Pulsed Drain-Source Diode	I _{SM}				24	А
Forward Current	12101				27	~

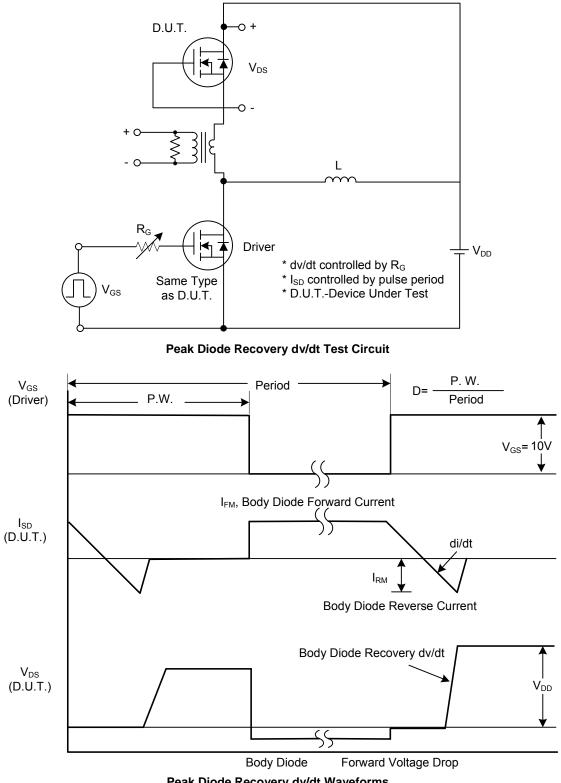
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%

2. Essentially independent of operating temperature

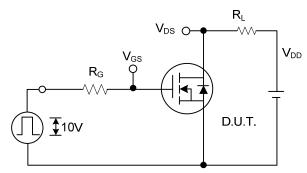


TEST CIRCUITS AND WAVEFORMS

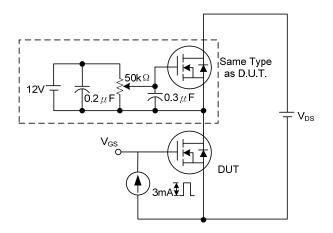




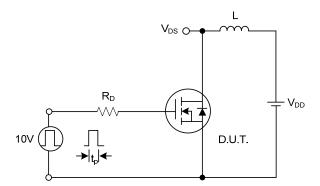
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



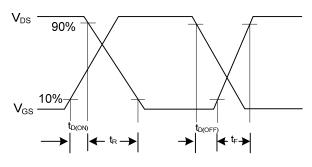




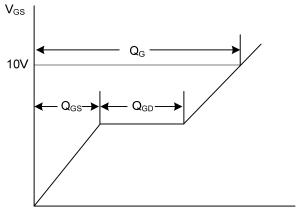
Gate Charge Test Circuit



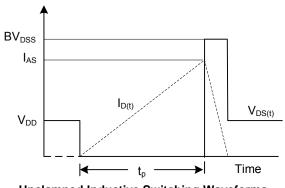
Unclamped Inductive Switching Test Circuit



Switching Waveforms



Charge Gate Charge Waveform

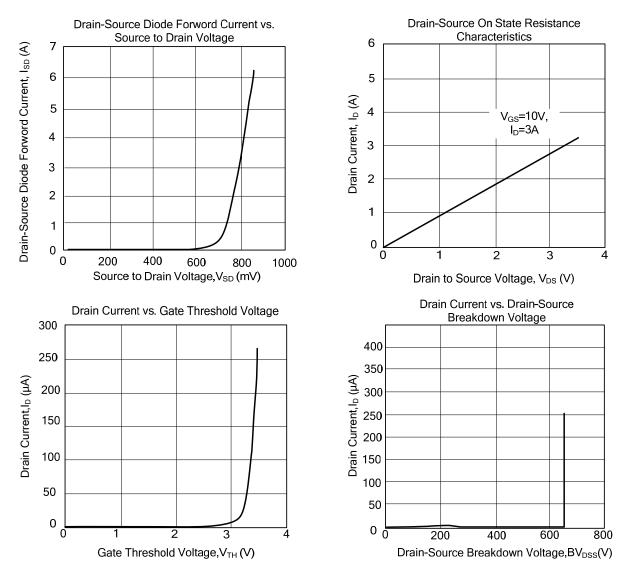


Unclamped Inductive Switching Waveforms



Power MOSFET

TYPICAL CHARACTERISTICS



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